

PATENT ASSIGNMENT

Electronic Version v1.1
 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT								
NATURE OF CONVEYANCE:	ASSIGNMENT								
CONVEYING PARTY DATA									
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Insoo KIM</td> <td>05/11/2012</td> </tr> <tr> <td>Chang-Gun LEE</td> <td>05/11/2012</td> </tr> <tr> <td>Tomoki KITAFUJI</td> <td>05/11/2012</td> </tr> </tbody> </table>		Name	Execution Date	Insoo KIM	05/11/2012	Chang-Gun LEE	05/11/2012	Tomoki KITAFUJI	05/11/2012
Name	Execution Date								
Insoo KIM	05/11/2012								
Chang-Gun LEE	05/11/2012								
Tomoki KITAFUJI	05/11/2012								
RECEIVING PARTY DATA									
Name:	TOKUSEN KOGYO CO., LTD.								
Street Address:	1081, Minamiyama Sumiyoshi-cho								
City:	Ono-city, Hyogo								
State/Country:	JAPAN								
Postal Code:	675-1361								
PROPERTY NUMBERS Total: 1									
<table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>13511424</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	13511424				
Property Type	Number								
Application Number:	13511424								
CORRESPONDENCE DATA									
Fax Number:	(202)659-9344								
Phone:	202-659-9076								
Email:	gdavis@roylance.com								
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent via US Mail.</i>									
Correspondent Name:	ROYLANCE, ABRAMS, BERDO & GOODMAN, LLP								
Address Line 1:	1300 19TH STREET, N.W.								
Address Line 2:	SUITE 600								
Address Line 4:	WASHINGTON,, DISTRICT OF COLUMBIA 20036								
ATTORNEY DOCKET NUMBER:	59396								
NAME OF SUBMITTER:	Garrett V. Davis								
Total Attachments: 2 source=59396_executed_assign#page1.tif source=59396_executed_assign#page2.tif									

OP \$40.00 13511424

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

ASSIGNMENT

WHEREAS, We, (1) Insoo KIM, (2) Chang-Gun LEE and (3) Tomoki KITAFUJI, citizens respectively of (1) Korea, (2) Korea and (3) Japan, residing respectively at (1) c/o Dong-A University, #840, Handan 2-dong, Saha-gu, Busan 604-714, KOREA, (2) 16-15 Bonggok-dong Jinju-shi Gyoungnam, KOREA, and (3) c/o TOKUSEN KOGYO CO., LTD., 1081, Minamiyama Sumiyoshi-cho, Ono-city, Hyogo 675-1361, JAPAN, (hereinafter ASSIGNORS), have made a certain invention entitled FINE METAL PARTICLE-CONTAINING COMPOSITION for which we are making application for Letters Patent of the United States, which application has been executed concurrently herewith; and

WHEREAS, TOKUSEN KOGYO CO., LTD., a corporation duly organized under the laws of JAPAN, located and doing business at 1081, Minamiyama Sumiyoshi-cho, Ono-city, Hyogo 675-1361, JAPAN (hereinafter ASSIGNEE), is desirous of acquiring the entire right, title and interest in and to the aforementioned invention and the aforementioned application and any and all Letters Patent to be obtained on said invention and/or application;

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN:

BE IT KNOWN that for good and valuable consideration paid to us by said ASSIGNEE the receipt and sufficiency of which is hereby acknowledged, we, the ASSIGNORS and, by these presents do hereby sell, assign, set over and transfer unto the said ASSIGNEE, its successors, legal representatives or assigns, the entire right, title and interest in and to the aforesaid invention in and for the United States and all countries foreign thereto; and in, to and under the aforesaid United States application and any corresponding foreign applications and any divisional, continuing, substitute or reissue applications or supplementary disclosures which may be filed on said invention in any country; and our right to file said foreign applications and claim priority under the provisions of the International Convention; and any Letters Patent of the United States or any foreign country issued or granted on said invention and/or said applications;


AND WE HEREBY authorize and request the Patent Office or other issuing authority to issue any and all patents on said invention and/or said application to said ASSIGNEE as sole assignee; and we further hereby authorize said ASSIGNEE to file and prosecute any of said foreign applications in its own name;

AND WE HEREBY covenant that we have the full right to convey the entire right, title and interest herein assigned and that we have not executed and will not execute any assignment or other instrument in conflict herewith;


AND WE HEREBY further covenant and agree to communicate to said ASSIGNEE, or its legal representatives, successors or assigns, any facts relating to said invention, including evidence for interference purposes or other proceedings, whenever requested, and to testify in any interference or in any other legal proceeding, when requested, and to execute and deliver on request all lawful papers required to make any of the foregoing provisions effective; and to perform the aforesaid communicating, executing and delivering, without any payment except expenses and to perform the aforesaid testifying for reasonable compensation; and generally to do everything possible to aid the said ASSIGNEE, its successors, legal representatives or assigns to obtain and enforce proper patent protection on and for said invention in all countries, and likewise we make these provisions binding upon our heirs, legal representatives and/or administrators.

IN WITNESS WHEREOF, we have hereunder set our hand and seal.

May 11, 2012
Date


Name: Insoo KIM

May 11, 2012
Date


Name: Chang-Gun LEE

May 11, 2012
Date


Name: Tomoki KITAFUJI